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SU-8 Process Optimization for High Fiber Coupling Efficiency of Liquid Crystal Filled Photonic Bandgap Fiber Components

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Abstract
SU-8 structures are built up to increase the fiber coupling efficiency of liquid crystal photonic bandgap fiber components. The resolution reduction of UV exposure is minimized to 4%, and insertion loss is reduced to 2.7dB.

Introduction
Infiltrating Liquid Crystals (LCs) into the capillaries of a Photonic Crystal Fiber (PCF) changes the fibers guiding principle from modified Total Internal Reflection (m-TIR) to bandgap guiding. Due to the physical properties of the LC, the optical characteristics of the Liquid Crystal infiltrated Photonic BandGap (LCPBG) fiber and its transmission spectrum can be tuned thermally, optically and electrically [1-10]. A compact polarimeter working at the 1550nm region has also been developed [8]. However, the insertion loss of this device is 10.5dB due to the misalignment of the Single Mode Fibers (SMFs) and PCF during the assembly.

Here, we experimentally improve the performance of this device by building up SU-8 fiber fixing structures on v-groove to maintain a good fiber coupling quality in device assembly. The SU-8 process is also optimized to minimize the resolution loss in UV exposure. Only 2.7dB insertion loss for the whole device is obtained.

Device and experiments

The cross section of the LCPBG device is illustrated in Fig. 1. The LC is infiltrated for 10 mm of the length of the fiber by using capillary forces, and then mounted between two v-grooves fabricated on a silicon substrate. Two SMF pigtails are also fixed in the grooves at each end of the LCPBG fiber for coupling in and out of the device. The Au electrodes are deposited on the side walls of the grooves, forming two orthogonal sets of electrodes. The electrode patterning is achieved by using thick photoresist coating and two-step exposure [11]. The assembly is sealed with epoxy, and the top and bottom sides of the device are electrically grounded.

In order to ensure a high fiber coupling quality, SU-8 fiber fixing structures are built up on the electrodes. The height of each structure is 80/g541m, since the space between top and bottom chips is D/1.414=88.4/g541m, where D is the outer diameter of the fiber (D=125/g541m). The distance between two neighboring structures is 126/g541m, taking the small variation of the fiber outer diameter into account. The profile of the edge bead resulting from the standard SU-8 process is shown in Fig. 2(a). The edge bead protrudes more than 30/g541m above the 80/g541m thick SU-8 film. This air gap between the mask and the resist reduces the theoretical resolution of UV exposure by 36% [12].

![Fig. 1. The cross section of the LCPBG fiber device.](image)

![Fig. 2. The profile scans of 80μm thick SU-8 film (a) before EBR and (b) after EBR. The quality of fiber coupling between SMF and PCF is improved by using SU-8 fiber fixers (c) before coupling and (d) after coupling.](image)
Minimizing the height of the edge bead is performed in three steps [13]: a solvent reduction bake, the actual edge bead removal (EBR), and a post-EBR spin cycle. The actual EBR is performed using the EBR functionality of the spin coater. While the wafer spins at 500 rpm, propylene glycol monomethyl ether acetate (PGMEA) is applied at the edge of the wafer through a needle. The secondary edge bead from the reflowed SU-8 is minimized by a spin cycle immediately after the EBR. Figure 2(b) shows the profile of SU-8 film after EBR. Only 3/55μm protuberance is observed, and the reduction of the theoretical resolution is minimized to 4%. Figure 2(c) and (d) show the coupling between SMF and PCF on the v-groove by using SU-8 fiber fixers. It is obvious to see that the coupling is improved and subsequently protected by SU-8 structures in the device assembly, which minimizes the misalignment in [8] and subsequently reduces the total insertion loss of the device.

The device is driven in bipolar mode by using two driving signals $V_s$, $-V_s$. The 1 kHz sine wave driving voltage $V_s$ for the device is generated by a signal generator and the phase-shifted signal $-V_s$ is generated by an inverter. $V_s$ and $-V_s$ are amplified using high-voltage amplifiers and the DC components of $V_s$ and $-V_s$ are removed by two 80Hz high-pass filters.

Figure 3 shows the transmission spectrum with applied voltage from 0Vrms to 200Vrms at room temperature. The notch in the transmission spectrum is caused by a cladding mode crossing through the bandgap starting at 1300nm, forming a so-called “avoided-crossing” with the core mode of the bandgap. This notch splits the whole bandgap into two parts. The same phenomenon has also been found by infiltrating PCFs with 90° splayed aligned LC MC-6608 [9]. It is evident that the short-wavelength edge is shifted towards longer wavelengths by increasing the voltage, while the long-wavelength edge of the same bandgap centered at 1500nm is almost kept in the original position. This feature is caused by different sensitivity of the PBG modes to the electrically induced alignment of LC [10]. At 200Vrms, an activation loss of 1.3dB is observed at 1500nm.

Conclusions
In conclusion, we experimentally minimize the resolution loss of the standard SU-8 process in UV exposure by removing the edge bead, and improve the fiber coupling quality by using SU-8 fiber fixing structures on LCPBG fiber device. The total insertion loss of this all-in-fiber device is 2.7dB. The electrical tunability of this compact device is also tested. With different driving voltages, an unbalanced shift of bandgap edge is found, which is caused by different sensitivity of the PBG modes to the electrically induced alignment of LC. The stable and compact design enables this all-in-fiber device easily integrated into communication or sensor systems.

References
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